

## N-Channel Enhancement Mode MOSFET

### 1. Product Information

#### Features

- High power and current handling capability
- Lead free product is acquired
- Surface mount package

#### Applications

- PWM applications
- Load switch
- Power management
- Halogen-free

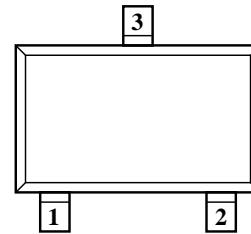
#### Quick reference

- $B_V \geq 20V$
- $I_D \leq 6.0A$
- $R_{DS(ON)} \leq 13m\Omega @ V_{GS} = 4.5V$  (Type:10 m $\Omega$ )
- $R_{DS(ON)} \leq 18m\Omega @ V_{GS} = 2.5V$  (Type:13 m $\Omega$ )

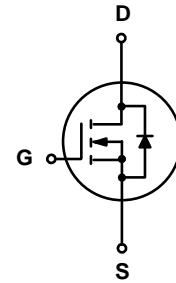
#### Pin Description

Pin	Description
1	Gate(G)
2	Source(S)
3	Drain(D)

#### Simplified Outline Symbol



Top View  
SOT23-3L



### Package Marking and Ordering Information

Product Name	Package	Marking	Reel Size	Tape width	Quantity
KJ2318A	SOT23-3L	<b>2318</b> YWWXXX	YWWXXX: Date Code		3000

### 2. Absolute Maximum Ratings ( $T_C=25^\circ C$ unless otherwise noted)

Parameter	Symbol	Value	Unit
Drain-Source Voltage	$V_{DS}$	20	V
Gate-Source Voltage	$V_{GS}$	$\pm 12$	
Continuous Drain Current	$I_D$	6	A
Pulsed Drain Current	$I_{DM}$	24	
Continuous Source-Drain Diode Current	$I_S$	1.64	
Maximum Power Dissipation	$P_D$	1.25	W
Thermal Resistance from Junction to Ambient	$R_{\theta JA}$		$^\circ C/W$
Junction Temperature	$T_J$	150	$^\circ C$
Storage Temperature	$T_{stg}$	-50 ~+150	

### 3. Electrical Characteristics (T<sub>J</sub>=25°C, unless otherwise noted)

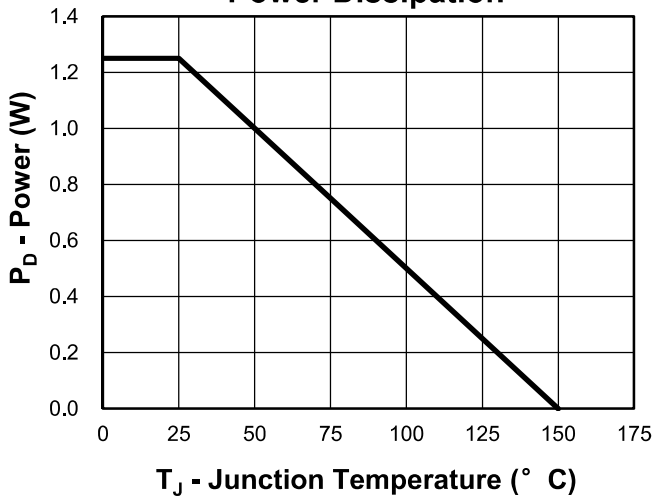
Parameter	Symbol	Test Condition	Min	Typ	Max	Unit
<b>Static</b>						
Drain-source breakdown voltage	V <sub>(BR)DSS</sub>	V <sub>GS</sub> = 0V, I <sub>D</sub> = 250μA	20			V
Gate-source leakage	I <sub>GSS</sub>	V <sub>DS</sub> = 0V, V <sub>GS</sub> = ±10V			±100	nA
Zero gate voltage drain current	I <sub>DSS</sub>	V <sub>DS</sub> = 20V, V <sub>GS</sub> = 0V			1.0	μA
Gate-source threshold voltage	V <sub>GS(th)</sub>	V <sub>DS</sub> = V <sub>GS</sub> , I <sub>D</sub> = 250μA	0.45	0.7	1.0	V
Drain-source on-state resistance <sup>a</sup>	R <sub>DS(on)</sub>	V <sub>GS</sub> = 4.5V, I <sub>D</sub> = 6.0A		0.010	0.0130	Ω
		V <sub>GS</sub> = 2.5V, I <sub>D</sub> = 4.7A		0.013	0.0180	
Forward tranconductance <sup>a</sup>	g <sub>fs</sub>	V <sub>DS</sub> = 10V, I <sub>D</sub> = 6.0A		6		S
<b>Dynamic<sup>b</sup></b>						
Input capacitance	C <sub>iss</sub>	V <sub>DS</sub> = 10V, V <sub>GS</sub> = 0V, f = 1MHz		565		pF
Output capacitance	C <sub>oss</sub>			125		
Reverse transfer capacitance	C <sub>rss</sub>			85		
Gate resistance	R <sub>g</sub>	f = 1MHz	0.5		4.8	Ω
Turn-on delay Time	t <sub>d(on)</sub>	V <sub>GEN</sub> = 5V, V <sub>DD</sub> = 10V, I <sub>D</sub> = 4A, R <sub>G</sub> = 1Ω, R <sub>L</sub> = 2.2Ω		8	16	ns
Rise time	t <sub>r</sub>			15	30	
Turn-off Delay time	t <sub>d(off)</sub>			33	66	
Fall yime	t <sub>f</sub>			13	26	
<b>Drain-source body diode characteristics</b>						
Forward diode voltage	V <sub>SD</sub>	V <sub>GS</sub> = 0V, I <sub>S</sub> = 4A		0.75	1.2	V

**Notes :**

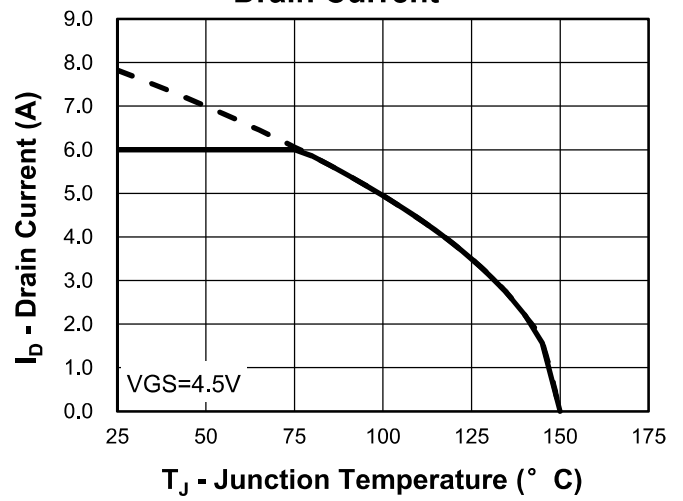
- Pulse Test : pulse width ≤ 300μs, duty cycle ≤ 2%.
- These parameters have no way to verify.

## 4. Typical Characteristics

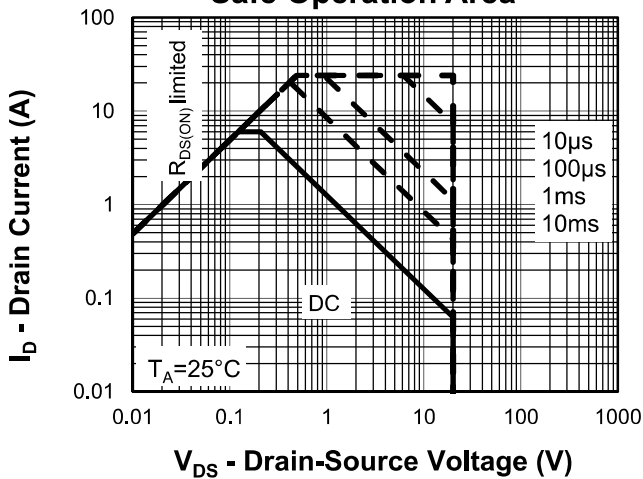
### Power Dissipation



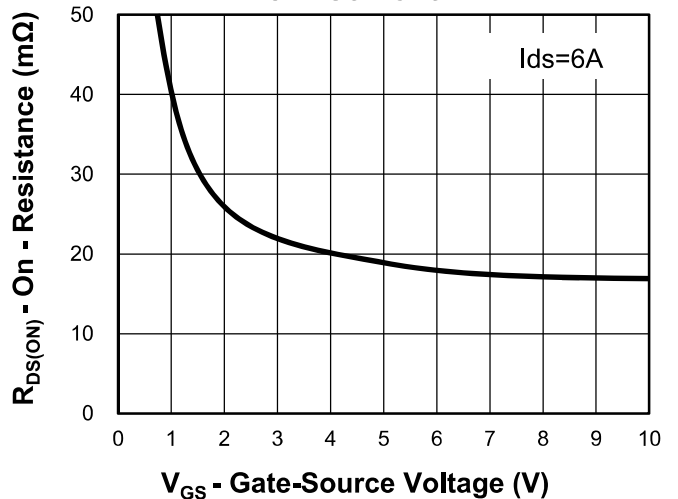
### Drain Current



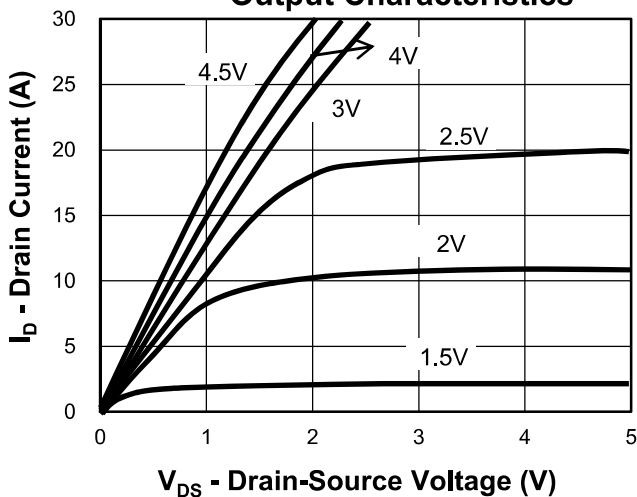
### Safe Operation Area



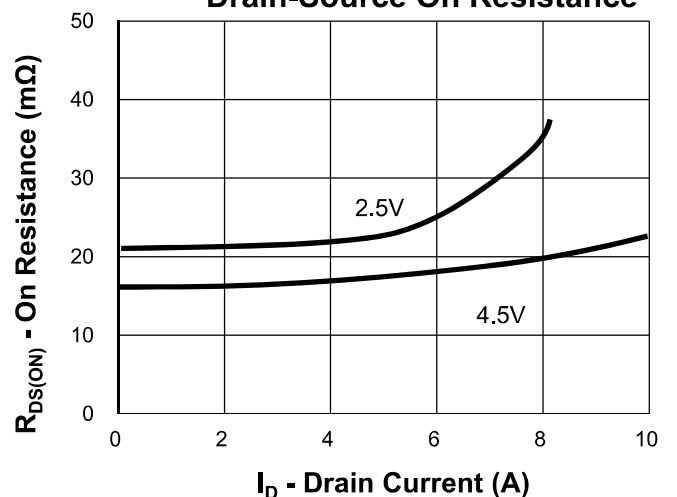
### Drain Current



### Output Characteristics



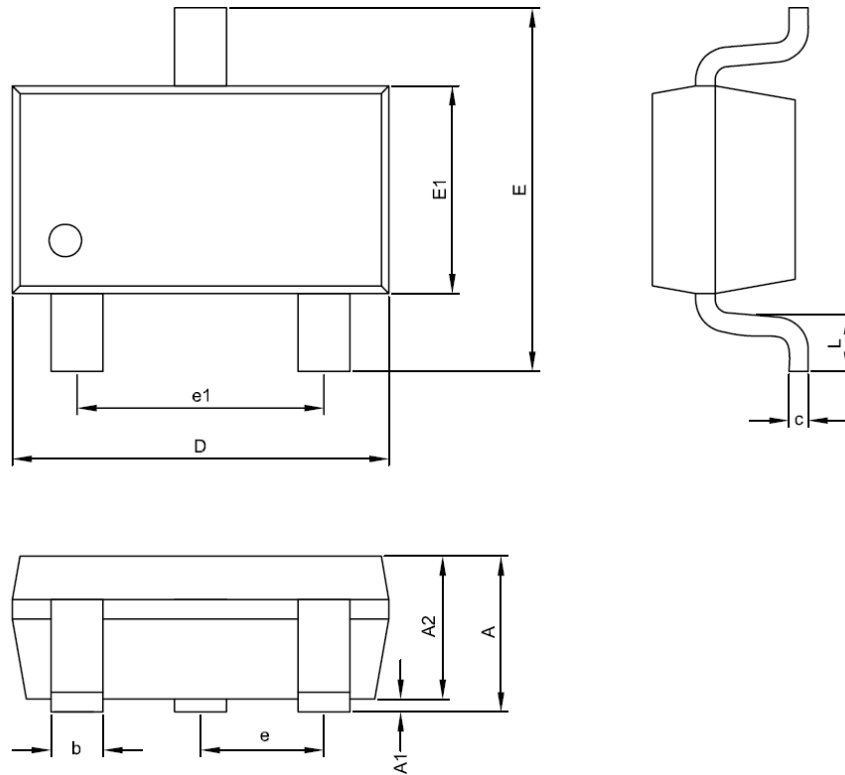
### Drain-Source On Resistance





### 5.Package Mechanical Data

SOT23-3L



Symbol	Dimensions In Millimeters	
	MIN.	MAX.
A	1.00	1.45
A1	0.00	0.15
A2	1.00	1.30
D	2.70	3.10
E	2.60	3.00
E1	1.50	1.70
c	0.08	0.25
b	0.30	0.50
e	0.95 BSC	
e1	1.90 BSC	
L	0.30	0.60